

N-Channel QFET[®] MOSFET

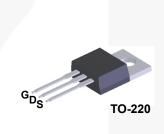
600 V, 7.5 A, 1.2 Ω

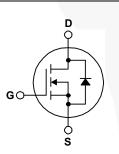
Description

These N-Channel enhancement mode power field effect transistors are produced using Fairchild's proprietary, planar stripe, DMOS technology. This advanced technology has been especially tailored to minimize on-state resistance, provide superior switching performance, and withstand high energy pulse in the avalanche and commutation mode. These devices are well suited for high efficiency switched mode power supplies, active power factor correction, electronic lamp ballasts based on half bridge topology.

Features

- 7.5 A, 600 V, $R_{DS(on)}$ = 1.2 Ω (Max.) @ V_{GS} = 10 V, I_{D} = 3.75 A
- Low Gate Charge (Typ. 28 nC)
- Low Crss (Typ. 12 pF)
- 100% Avalanche Tested





Absolute Maximum Ratings T_c = 25°C unless otherwise noted.

Symbol	Parameter		FQP8N60C	Unit	
V _{DSS}	Drain-Source Voltage		600	V	
I _D	Drain Current - Continuous (T _C = 25°C	2)	7.5	A	
	- Continuous (T _C = 100°	°C)	4.6	A	
DM	Drain Current - Pulsed	(Note 1)	30	A	
V _{GSS}	Gate-Source Voltage		± 30	V	
E _{AS}	Single Pulsed Avalanche Energy	(Note 2)	230	mJ	
AR	Avalanche Current	(Note 1)	7.5	A	
E _{AR}	Repetitive Avalanche Energy	(Note 1)	14.7	mJ	
dv/dt	Peak Diode Recovery dv/dt	(Note 3)	4.5	V/ns	
P _D	Power Dissipation (T _C = 25°C)		147	W	
	- Derate above 25°C		1.18	W/°C	
T _J , T _{STG}	Operating and Storage Temperature Range	ge	-55 to +150	°C	
Τ _L	Maximum lead temperature for soldering 1/8" from case for 5 seconds	purposes,	300	°C	

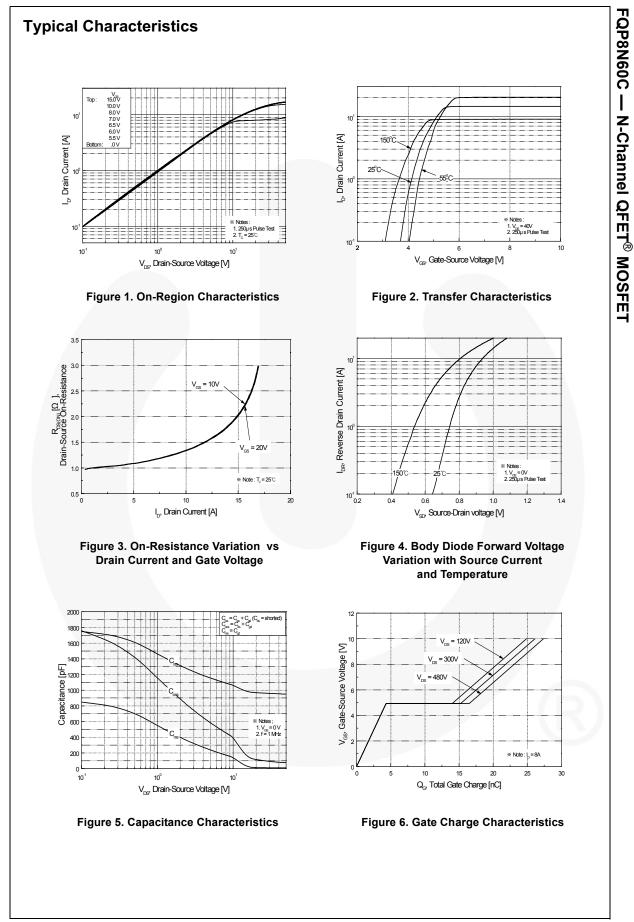
* Drain current limited by maximum junction temperature.

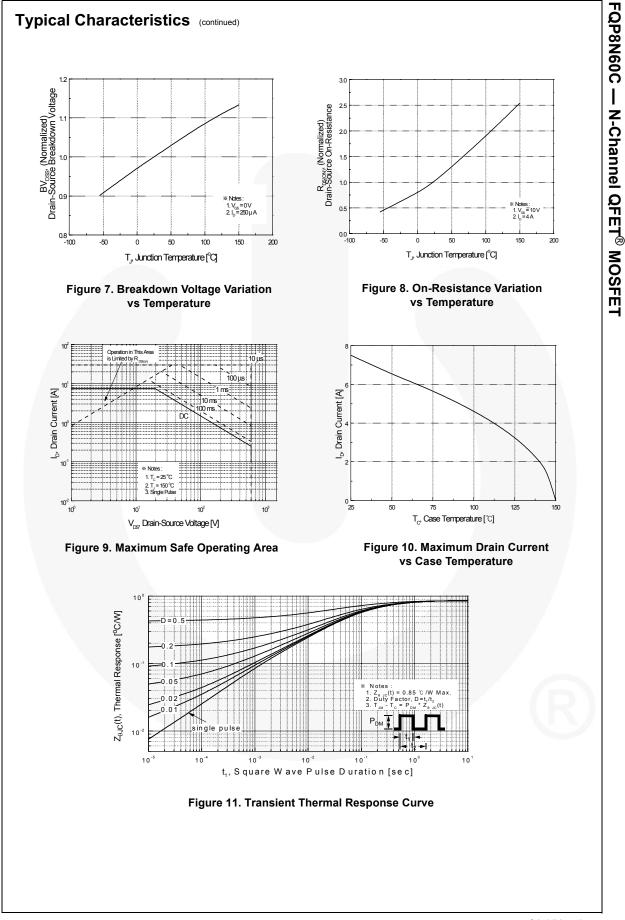
Thermal Characteristics

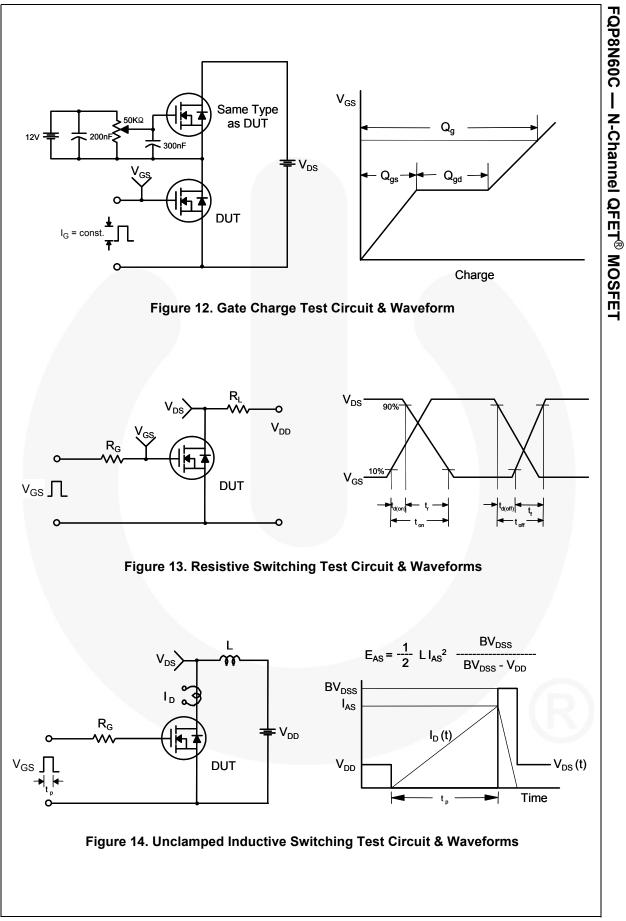
Symbol	Parameter	FQP8N60C	Unit
$R_{\theta JC}$	Thermal Resistance, Junction-to-Case, Max.	0.85	°C/W
$R_{ extsf{ heta}JA}$	Thermal Resistance, Junction-to-Ambient, Max.	62.5	°C/W

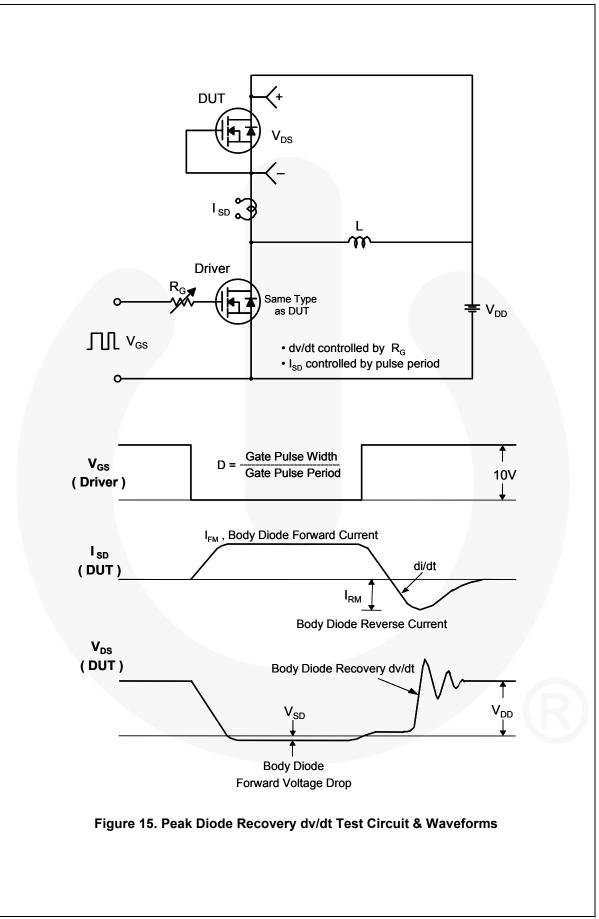
April 2014

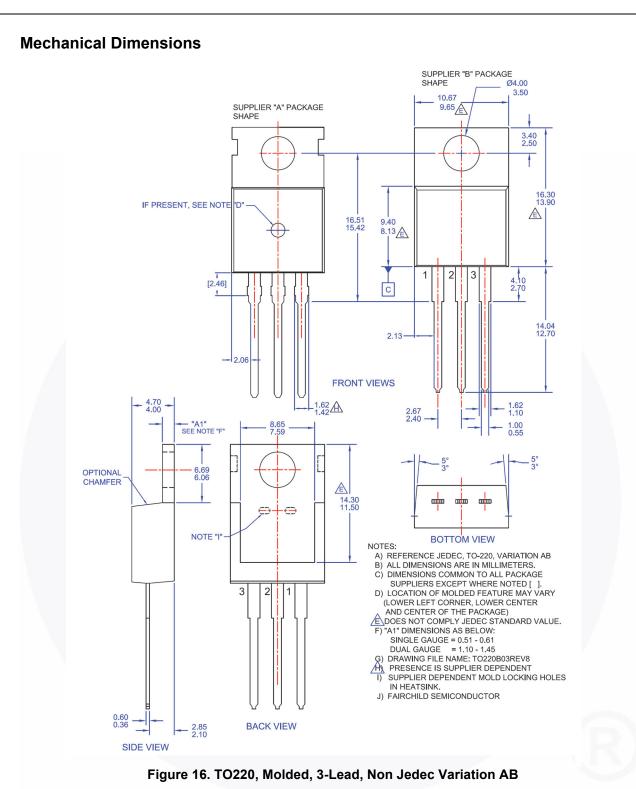
Symbol Off Cha BV _{DSS} ABV _{DSS} AT _J	cal Ch	FQP8N60C				Reel	Size			Quantity
Symbol Off Cha BV _{DSS} ΔBV _{DSS} ΔT _J			TO-2	220 Tube N/		A	N/A		50 units	
Off Cha ^{3V_{DSS} ΔBV_{DSS} ΔT_J}	racteri	aracteristics	T _c = 25°C unl	ess otherv	vise noted.					
Off Cha BV _{DSS} ΔBV _{DSS} / ΔT _J	racteri	Parameter			Test Conditions		Min	Тур	Max	Unit
ΔBV _{DSS} ′ΔT _J		stics								
ΔT_{J}	Drain-Se	ource Breakdown Volt	age	V_{GS} =	0 V, I _D = 250 μA		600			V
DSS	Breakdown Voltage Temperature Coefficient Zero Gate Voltage Drain Current Gate-Body Leakage Current, Forward Gate-Body Leakage Current, Reverse		$I_{D} = 250 \ \mu\text{A}, \text{ Referenced to } 25^{\circ}\text{C}$ $V_{DS} = 600 \ \text{V}, \ V_{GS} = 0 \ \text{V}$ $V_{DS} = 480 \ \text{V}, \ T_{C} = 125^{\circ}\text{C}$ $V_{GS} = 30 \ \text{V}, \ V_{DS} = 0 \ \text{V}$				0.7	 1 10	V/°C μΑ μΑ	
200										
GSSF								100	nA	
GSSF				$V_{GS} = -30 \text{ V}, \text{ V}_{DS} = 0 \text{ V}$					-100	nA
				•65					-100	ПА
On Cha V _{GS(th)}		reshold Voltage	_	Vac =	V _{GS} , I _D = 250 μA		2.0		4.0	V
GS(th) R _{DS(on)}	Static D	rain-Source		-	10 V, I _D = 3.75 A			1.0	1.2	Ω
9 _{FS}	On-Res Forward	I Transconductance		V _{DS} = 40 V, I _D = 3.75 A				8.7		S
Dynami	c Char	acteristics								
C _{iss}	Input Ca	apacitance		V _D e =	25 V, V _{GS} = 0 V,			965	1255	pF
C _{oss}	Output (Capacitance		f = 1.0				105	135	pF
C _{rss}	Reverse	Transfer Capacitance	e					12	16	pF
	Ok .									
d(on)	Turn-Or	Delay Time	_		300 V, I _D = 7.5 A,			16.5 60.5	45 130	ns
d(on) r	Turn-Or Turn-Or	n Delay Time n Rise Time		V _{DD} = R _G = 2				60.5	130	ns
d(on) r d(off)	Turn-Or Turn-Or Turn-Of	Delay Time Rise Time f Delay Time			25 Ω	(Note 4)		60.5 81	130 170	ns ns
d(on) r d(off) f	Turn-Or Turn-Or Turn-Of Turn-Of	n Delay Time n Rise Time f Delay Time f Fall Time		R _G = 2	25 Ω	(Note 4)		60.5 81 64.5	130 170 140	ns ns ns
d(on) r d(off) f Q _g	Turn-Or Turn-Or Turn-Off Turn-Off Total Ga	n Delay Time n Rise Time f Delay Time f Fall Time ate Charge		R _G = 2	25 Ω 480 V, I _D = 7.5 A,	(Note 4)		60.5 81 64.5 28	130 170	ns ns ns nC
d(on) r d(off) f Q _g Q _{gs}	Turn-Or Turn-Of Turn-Off Turn-Off Total Ga Gate-Sc	a Delay Time n Rise Time f Delay Time f Fall Time ate Charge purce Charge		R _G = 2	25 Ω 480 V, I _D = 7.5 A,	(Note 4)		60.5 81 64.5	130 170 140 36	ns ns ns nC nC
$\begin{array}{c} d(on) \\ \hline r \\ \hline d(off) \\ \hline f \\ Q_g \\ Q_{gs} \\ Q_{gd} \end{array}$	Turn-Or Turn-Of Turn-Off Turn-Off Total Ga Gate-Sc Gate-Dr	n Delay Time n Rise Time f Delay Time f Fall Time ate Charge	istics ar	R _G = 2 V _{DS} = V _{GS} =	25 Ω 480 V, I _D = 7.5 A, 10 V		 	60.5 81 64.5 28 4.5	130 170 140 36 	ns ns ns nC
$\begin{array}{c} d(on) \\ r \\ d(off) \\ f \\ \lambda_{g} \\ \lambda_{gs} \\ \lambda_{gd} \end{array}$	Turn-Or Turn-Or Turn-Off Turn-Off Total Ga Gate-So Gate-Dr	a Delay Time a Rise Time f Delay Time f Fall Time ate Charge ource Charge ain Charge		R _G = 2 V _{DS} = V _{GS} =	25 Ω 480 V, I _D = 7.5 A, 10 V kimum Ratings		 	60.5 81 64.5 28 4.5	130 170 140 36 	ns ns ns nC nC
d(on) r d(off) f Q _g Q _{gs} Q _{gd} Drain-S s	Turn-Or Turn-Or Turn-Of Turn-Off Total Ga Gate-Sc Gate-Dr Ource I Maximu	a Delay Time a Rise Time f Delay Time f Fall Time ate Charge purce Charge ain Charge Diode Characteri	Source Dio	$R_G = 2$ $V_{DS} =$ $V_{GS} =$ Ind Max de Forw	25 Ω 480 V, I _D = 7.5 A, 10 V kimum Ratings vard Current		 	60.5 81 64.5 28 4.5 12	130 170 140 36 	ns ns nC nC nC
$\frac{d(on)}{r}$ $\frac{d(off)}{f}$ $\frac{\lambda_{g}}{\lambda_{gs}}$ $\frac{\lambda_{gd}}{Drain-S}$	Turn-Or Turn-Or Turn-Off Turn-Off Total Ga Gate-Sc Gate-Dr Ource I Maximu Maximu	a Delay Time a Rise Time f Delay Time f Fall Time ate Charge purce Charge ain Charge Diode Characteri m Continuous Drain-S	Source Dio ce Diode F	$R_{G} = 2$ $V_{DS} =$ $V_{GS} =$ $M Max$ $M ax$ $M ax$ $M ax$	25 Ω 480 V, I _D = 7.5 A, 10 V kimum Ratings vard Current		 	60.5 81 64.5 28 4.5 12	130 170 140 36 7.5	ns ns nC nC nC A
d(on) r d(off) f λ_{g} λ_{gs} λ_{gd} Drain-S s SM	Turn-Or Turn-Or Turn-Of Turn-Of Total Ga Gate-Sc Gate-Dr Ource I Maximu Maximu Drain-Sc	a Delay Time a Rise Time f Delay Time f Fall Time ate Charge ource Charge ain Charge Diode Characteri m Continuous Drain-S m Pulsed Drain-Source	Source Dio ce Diode F	$R_{G} = 2$ $V_{DS} =$ $V_{GS} =$ $M Max$ $M ax$	480 V, $I_D = 7.5$ A, 10 V kimum Ratings rard Current Current		 	60.5 81 64.5 28 4.5 12	130 170 140 36 7.5 30	ns ns nC nC nC A A











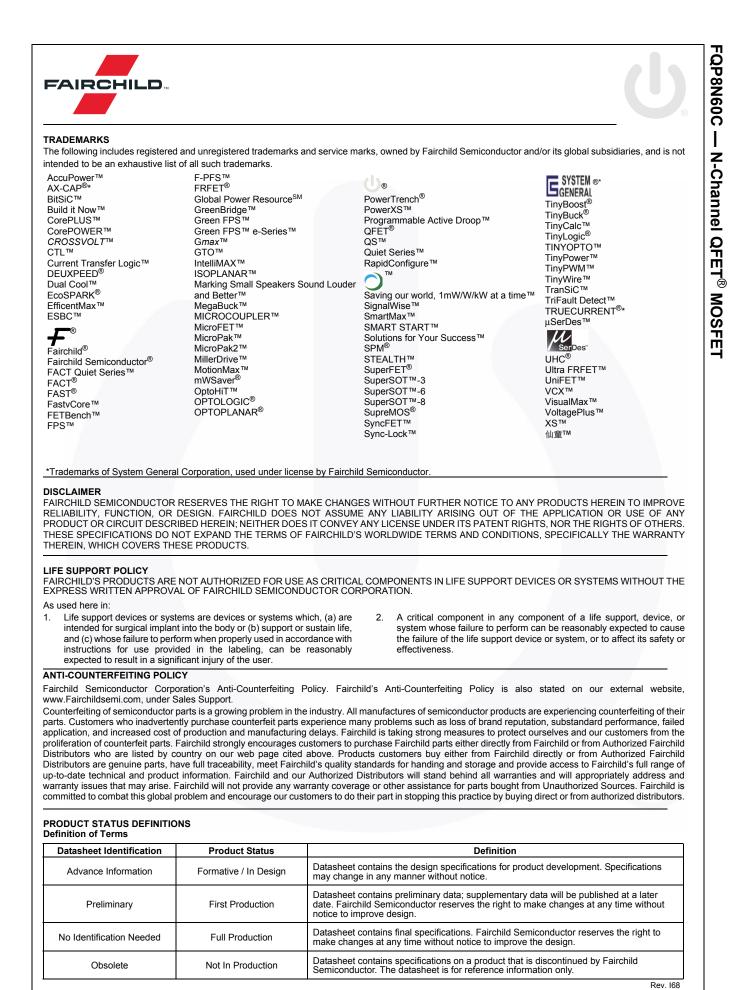
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